

Application Note #000005





# Transport and RF-reflectometry measurements of CMOS nanodevices

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# Introduction

Pioneering work on semiconductor quantum dots has shown that quantum dots are promising candidates as a building block (qubit) for quantum information and computation. Quantum dots are quasi-zero-dimensional nanostructures which can confine single electrons, whose spin or charge degree of freedom can then be used to represent quantum bits (qubits).

Quantum computing approaches based on build semiconductors can upon mature micro/nano-fabrication technologies, which will be invaluable in scaling up to a large number of reproducible gubits with practical yields and integrated electronics. As part of the classical information technology industry, CMOS transistors have reached sufficiently small feature sizes that quantum effects can begin to play a dominant role. This motivates the exploration of quantum effects in such transistors fabricated using CMOS processes.

## Equipment Used

- Triton 200 Dilution Refrigerator
- Nanonis Tramea including optional lockin module
- SR830 lock-in amplifier (for comparison)

#### **Experimental Setup**

In this note, we describe experiments on quantum dots created within CMOS finFET (fin Field Effect Transistor) devices.

The transistor consists of multiple silicon fins, sitting on an insulating oxide layer, sharing a common source and drain as well as a wraparound top-gate which is used to control conduction through the fins. Further control is possible by the bulk silicon substrate which can be used as a back-gate.

The field effect of the top-gate is greatest in the corners of the fin cross-section, due to its geometry. This leads to formation of quantum dots when operating the fin-FET sub-threshold, which can be observed at cryogenic temperatures (see transfer curves at 300 K and



Figure 1 Measurement setup for RF reflectometry and finFET device



30 mK in Figure 1).

As an alternative to measurements based on transport through the FET, it is possible to characterise, with high sensitivity, the charge transitions of quantum dots even when no signal in transport can be detected. This is achieved by using the top-gate as a dispersive sensor measuring small changes in the capacitance of the device originating from the tunnelling of single electrons, detected by the response of an *LC* resonator at radio-frequency (RF). The high sensitivity and bandwidth of this measurement makes it ideal for studying the transistor in a regime where transport is pinched off.

In such gate-based RF-reflectometry, weak modulation is applied to the top-gate via a bias tee, close to the resonance frequency of an *LC* circuit consisting of a surface mount inductor and the parasitic capacitance of the PCB and device itself (see Figure 1). The reflected RF signal is amplified at multiple stages followed by

IQ-demodulation to obtain the amplitude and phase of the reflected signal. A change in phase of the reflected signal relates to an effective change in device capacitance.

### Results

Transport measurements of a quantum dot rely on electrons being able to tunnel on and off the dot. Detecting such electron tunnelling requires the ability to measure very small currents (on the order of picoamps). Furthermore, as tunnel barriers become less transparent, transport measurements become more and more challenging, and substantial integration may be required to achieve adequate signal/noise.

In contrast, RF-reflectometry allows fast and sensitive measurements even when tunnel barriers are in-transparent. However, such measurements are often more complicated to interpret as the signal originates from any change in device capacitance.



Figure 2 (Left) Transport measurement using GPIB interfaced SR830. (Right) Transport measurement using Nanonis Tramea system.





Figure 4 Reflectometry measurement using Nanonis Tramea system

The Nanonis Tramea quantum transport measurement system is able to improve current characterization procedures in various ways. The integrated solution of very fast logic, data acquisition and storage combined with low-noise inputs allows for an enhancement in the speed of transport measurements, for example by reducing the communication time present when separate instruments (e.g. lock-in amplifiers) are used. Furthermore, transport and reflectometry measurements can be performed simultaneously, allowing for a direct comparison between the two methods. By removing the bandwidth limitation of the previous acquisition system the speed advantage of reflectometry is even more pronounced. This can be quite powerful when exploring a new device where specific operating regions need to be identified by large scans within the parameter space.

A large gate map from a device studied in transport, taken with a GPIB-interfaced lock-in amplifier controlled using a measurement computer, can take several hours. An example is given in the left side of Figure 2 which shows Coulomb oscillations as a function of bulk and top-gate voltage. With the Tramea system a similar scan (right side of Figure 2) can be obtained in only 10 minutes at the same resolution. Additionally, by comparing the 2 hour acquisition with the 10 minute scans we observe a drift or instability in the 2 hour scan which is not apparent in the fast scan. Stable and precise voltage sources are other key factors for such measurements as they can last several days and quantum devices have small tolerance levels.

By feeding the I and Q outputs from the IQdemodulator into two other Tramea inputs, we can obtain a reflectometry scan (Figure 3) simultaneously with the direct transport measurement. Comparing the reflectometry with the transport scan (Figure 3 with right side of Figure 2) we observe many additional oscillations at low gate voltage, where tunnel barriers have



**Reflectometry Phase Signal** 

Figure 3 Simultaneously acquired transport measurements using the DC signals (left) and the reflectometry technique (right).



become opaque.

For further quantum dot characterisation we take a scan varying the source-drain and topgate voltage. Similar to the previous measurement, we observe the familiar Coulomb diamonds compatible with multiple quantum dots in transport and reflectometry. The left side of Figure 4 is the transport measurements from the Tramea system while the right side of Figure 4 is the simultaneous data acquired using the reflectometry technique.

#### Conclusion

In summary, we have studied a CMOS fin-FET device. At cryogenic temperatures we observed signatures consistent with multiple quantum dots. Using the Nanonis Tramea system we were able to significantly speed up the characterisation process and simultaneously obtain transport and RF-reflectometry data which is very important when exploring the parameter space of a new device.

#### Additional reading

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